

QE for Motor V1.7.0

Release Note

Thank you very much for using the QE for Motor V1.7.0.

This release note covers product installation, restrictions, and so on. Please read this document before using the product.

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1. About QE for Motor

1.1 Overview

QE for Motor is an assistance tool for applications that operates in the e² studio integrated development environment. For the development of embedded systems that include motor software and are based on the Renesas MCUs, this product offers the following features.

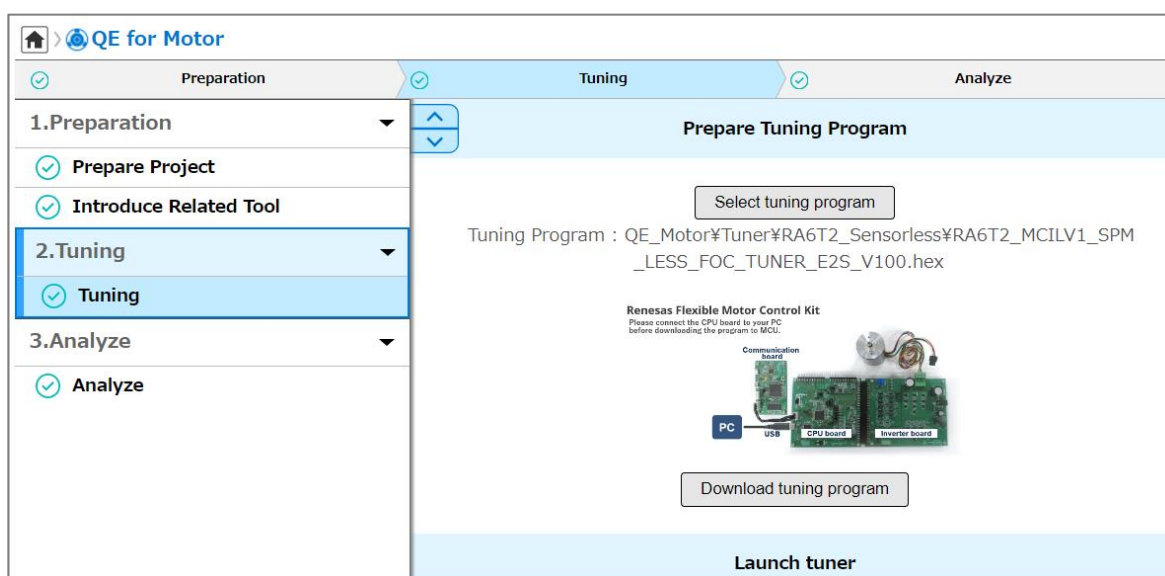
- Configuration of motor middleware and related drivers such as Flexible Software Package (FSP)
- Assistance in tuning and analysis in coordination with the Renesas Motor Workbench

1.2 Features

QE for Motor has the three features below for supporting the development of motor software.

1. Workflow View

Following the workflow in the [Motor Workflow (QE)] view enables configuration of the middleware and related drivers for motors. Also, tuning and analysis can be implemented through coordination with the Renesas Motor Workbench.



The workflow view can be opened from [Renesas Views] – [Renesas QE] – [Motor Workflow (QE)] Men. The display functions of the workflow view are as follows.

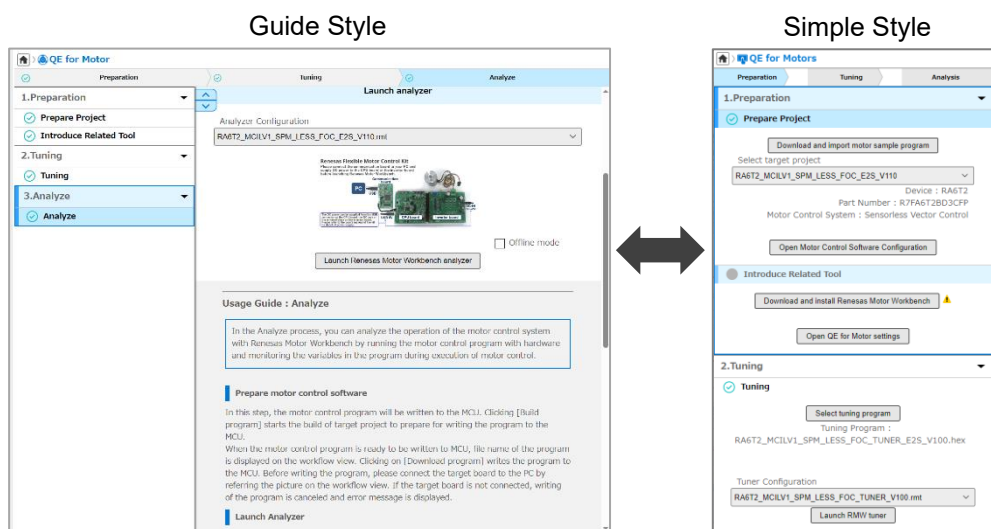
■ Display mode

2 display modes, guide style and simple style are supported. The display mode is automatically switched by the window size.

Guide style : Click each menu on the left to display the setting items. Steps are performed from top to bottom in the menu.

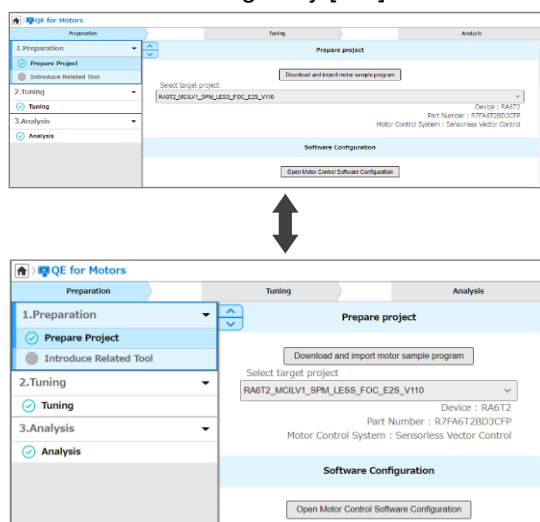
Simple style : All setting items are displayed. Steps are performed from top to bottom in the workflow.

* The setting items for both styles are the same as for the old workflow.



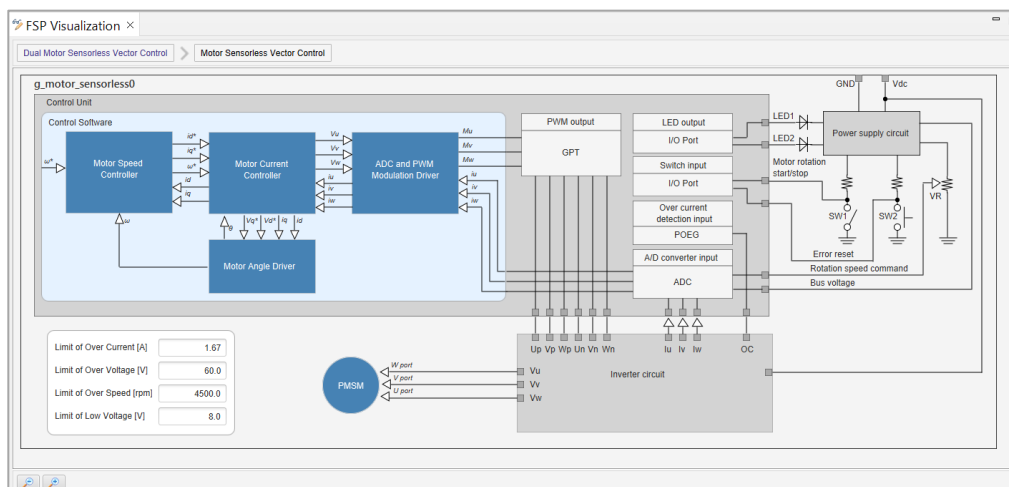
■ Display size

Display size of GUI items can be changed by [Ctrl] + mouse wheel.

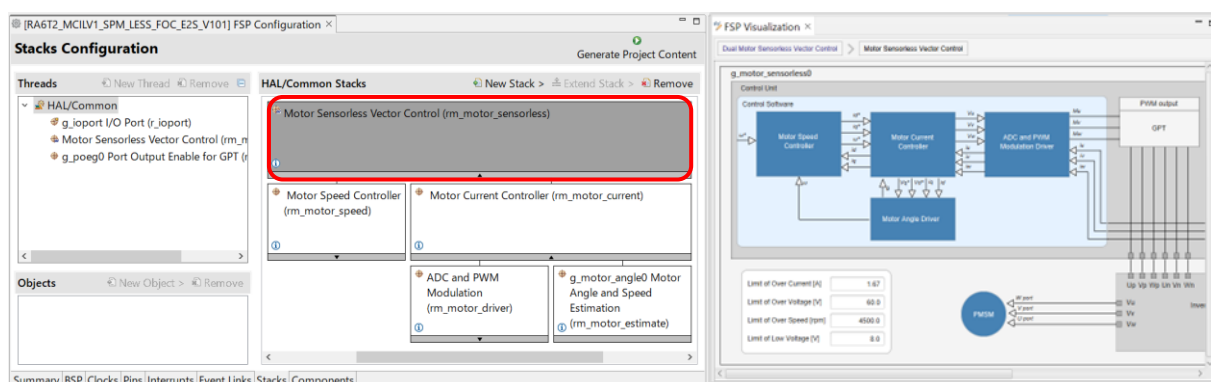


2. Motor software configuration GUI

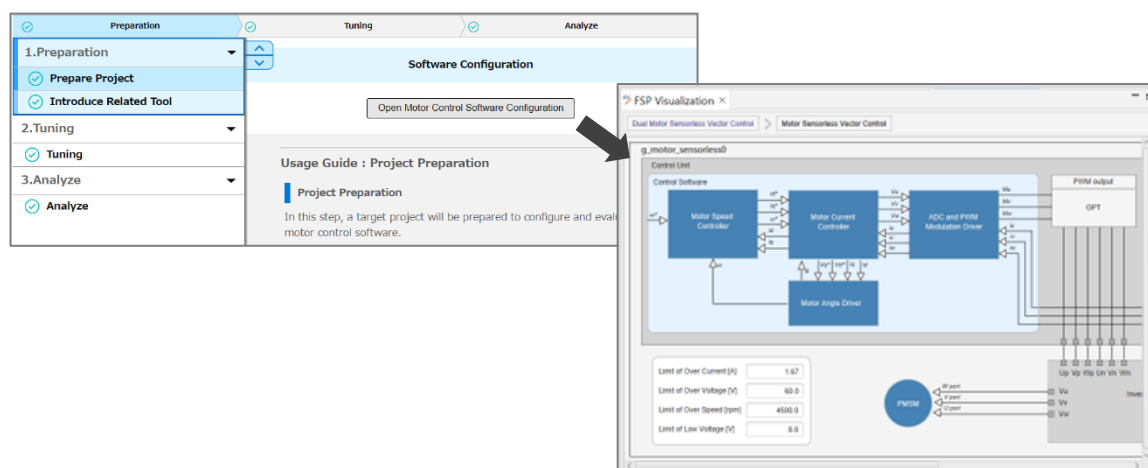
By changing the parameters of the motor control system in the GUI, you can configure the middleware and related drivers for motors. The hierarchical structures of the block diagram enable efficient operations.



For RA family devices, the motor software configuration GUI is displayed in the [FSP Visualization] view of the e² studio. The [FSP Visualization] view is opened in the [FSP Configuration] perspective. The [FSP Visualization] view can also be opened from the main menu of the e² studio, by selecting [Renesas Views] -> [C/C++] -> [FSP Visualization]. The motor software configuration GUI is displayed when selecting the stack of the FSP module listed in **1.4 Supported Software of Motor Software Configuration GUI** on the [Stacks] tabbed page of the FSP configuration editor.

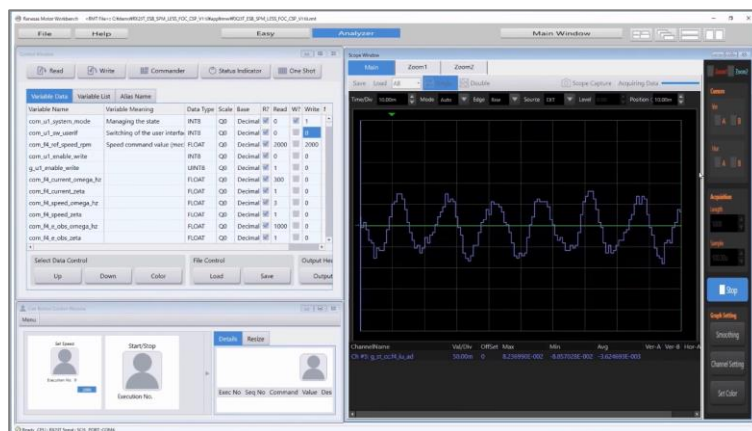


For RX family devices, the motor software configuration GUI is displayed in the [Motor Middleware Configurator (QE)] view of the e² studio. The [Motor Middleware Configurator (QE)] view is opened by selecting the sample project supporting this feature and clicking [Start Configuration] button on [Motor Main (QE)] view. For the sample projects supporting this feature, refer to **1.4 Supported Software of Motor Software Configuration GUI**.



3. Coordination with the Renesas Motor Workbench

QE for Motor can operate in coordination with the Renesas Motor Workbench for the processes of tuning and analysis of the motor. Since QE for Motor automatically makes the necessary settings for starting the Renesas Motor Workbench, you can tune and analyze the motor by clicking on the buttons in the window of QE for Motor.



4. Supported MCUs

QE for Motor supports the following MCUs.

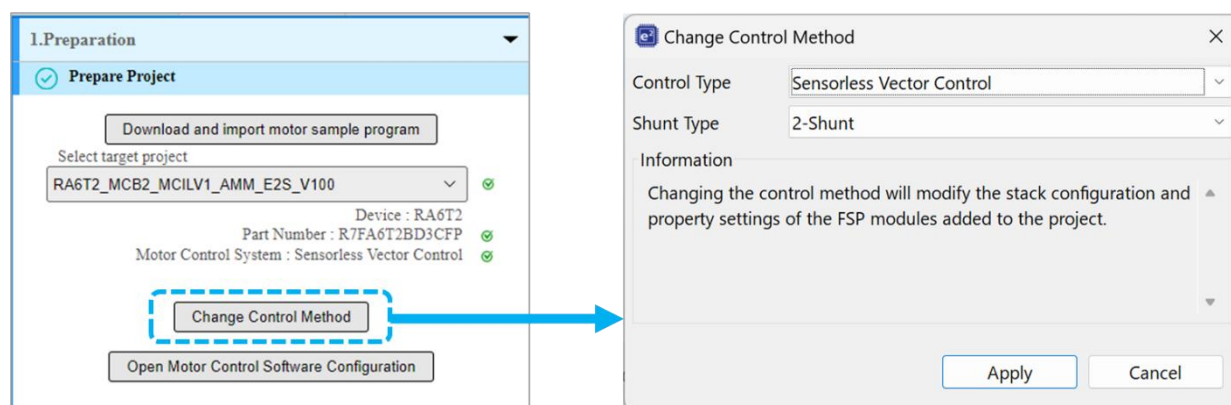
RL78/G1F, RL78/G24, RA2T1, RA4T1, RA6T2, RA6T3, RA8T1, RA8T2, RX14T and RX26T

1.3 Changes in V1.7.0

1.3.1 Added RAMP Support for RA4T1, RA6T3, RA8T1, and RA8T2

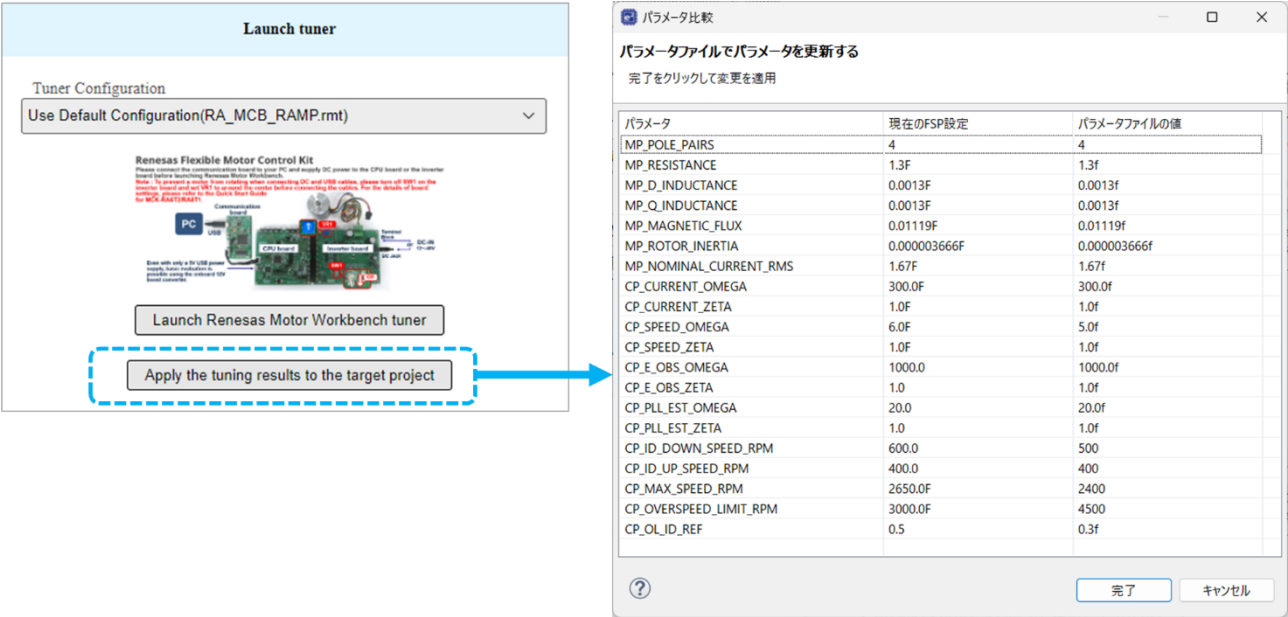
The control method configuration feature for the RAMP (Renesas Advanced Motor Control Platform) FSP modules has been extended to support RA4T1, RA6T3, RA8T1, and RA8T2, in addition to the existing RA6T2 support.

When a project using the RAMP Motor Control (`rm_motor_control`) module is selected, the [Change Control Method] button becomes enabled, allowing you to modify the motor control method. After electing the control method in the [Change Control Method] dialog and clicking [Apply], the FSP stacks and properties will be updated accordingly.



Additionally, for projects using the same module, the [Apply the tuning results to the target project] button allows you to apply parameters obtained from the Tuner function of Renesas Motor Workbench to the

FSP configuration of the target project. After performing tuning with the Tuner function of Renesas Motor Workbench and outputting the results to a header file, this button becomes enabled. The [Parameter Comparison] dialog, opened from this button, displays both the current FSP settings and the parameter values from the header file.



Sample projects that use the RAMP Motor Control (rm_motor_control) module can be imported into e²studio from the wizard opened via the [Download and import sample program] button in the Workflow view.

1.4 Supported Software of Motor Software Configuration GUI

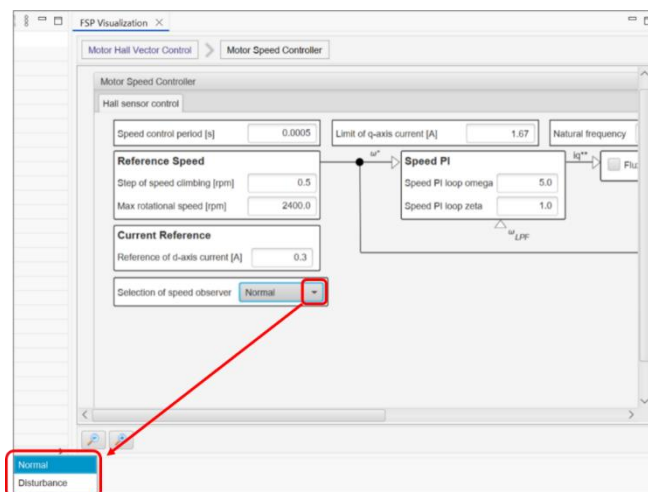
- RA Flexible Software Package (FSP)
 - Motor Middleware
 - Motor Sensorless Vector Control: rm_motor_sensorless
 - Motor Encoder Vector Control: rm_motor_encoder
 - 120-degree control: rm_motor_120_degree
 - Motor Vector Control with hall sensors: rm_motor_hall
 - Motor Vector Control with induction sensor: rm_motor_induction
 - RAMP(Renesas Advanced Motor control Platform)
 - RA4T1, Motor Control (BEMF/Hall Sensor)
 - RA6T2, Motor Control (BEMF/Hall Sensor)
 - RA6T3, Motor Control (BEMF/Hall Sensor)
 - RA8T1, Motor Control (BEMF/Hall Sensor)
 - RA8T2, Motor Control (BEMF/Hall Sensor)
- RX14T, RX26T sample projects
 - Sensorless Vector Control of a Permanent Magnet Synchronous Motor For MCK
 - Vector Control for Permanent Magnet Synchronous Motor with Encoder For MCK

2. Installation, Uninstallation and Updating the Product

Refer to <https://www.renesas.com/software-tool/qe-support>

3. Functional Restrictions

When using multiple monitors, the options in a combo box on the motor software configuration window may appear in a different position than the combo box itself.



4. Operating Environment

System: x64 based processor

Windows® 11

Supported Tools

e² studio 2026-07

Renesas Motor Workbench 3.3.1

Revision History

Rev.	Date	Description	
		Page	Summary
1.00	Sep.30.26	-	First edition issued.

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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